

Attorney Docket No. 09792909-5727

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hirata, K.

Serial No.: 10/705,552

Filed: November 11, 2003

For: SOLID-STATE IMAGING DEVICE AND METHOD FOR MANUFACTURING THE

SAME

Case No.: 09792909-5727

Examiner: Nguyen, J. H.

Group Art Unit: 2815

Confirmation No. 5105

Certificate of Mailing (37 CFR 1.8(a))

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to:

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450 on:

Date of Deposit:

Robards Swartzne Sully

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

DECLARATION OF KIYOSHI HIRATA UNDER 37 C.F.R. §1.131

Dear Sir:

- 1. I, Kiyoshi Hirata, am the sole the inventor of Solid-State Imaging Device and Method for Manufacturing the Same, which is the subject matter of the application for United States Patent Application No. 10/705,552, filed November 11, 2003.
- 2. United States Patent Application No. 10/705,552 claims priority to Japanese Patent Application No. P2002-330150, filed on November 12, 2002.
- 3. In the Office Action mailed on April 14, 2005, the Examiner cited as prior art under 35 U.S.C. §102(e) the reference <u>Inagaki</u> (U.S. Pat. No. 6,765,246) to reject pending claims 1-5. The <u>Inagaki</u> reference has a filing date of August 21, 2002, and a prior publication date of May 8, 2003.
- 4. This is a declaration of prior invention to overcome <u>Inagaki</u>. As inventor of the subject matter of the rejected claims, I hereby submit this declaration to overcome <u>Inagaki</u>.

- 5. Exhibit A is an English-language translation of an Invention Report that I prepared and submitted to my employer before August 21, 2002 ("Invention Report"), the filing date of <u>Inagaki</u>. A certification of translation is also submitted herewith at Exhibit B. The dates have been redacted from Exhibits A and B.
- 6. The Invention Report discloses conception of the subject matter of at least claims 1-5 of Application Serial No. 10/705,552. Specifically, the Invention Report discloses a method of manufacturing a solid state imaging device including forming a photosensor in the surface of a substrate (see e.g., page 2 of translated Invention Report, which states that "electric charges, into which received light is photo-electrically converted, are mixed with adjacent pixels . . ."), and forming a channel stop section on the side of the photosensor in the substrate by multiple times of ion implantation with multiple implantation energies (see e.g., page 1 of translated Invention Report, referring to "A channel stop structure in which multiple-stage implantation is carried out . . . by changing energy."), wherein the ion implantation area and/or the ion concentrations may be changed. (See, e.g., page 1 of Invention Report, items 3 and 4).
- 7. Japanese Patent Application No. P2002-330150 was filed on November 12, 2002. I declare that between the date of conception and the filing of this Japanese Patent Application, my representatives and I worked reasonably hard and expeditiously to prepare, execute and file the Japanese Patent Application. I reserve the right to show reduction to practice via the Invention Report itself or other acts in addition to the filing of the Japanese Patent Application.
- 8. I allege that the acts relied upon to establish an invention date prior to the filing date of <u>Inagaki</u> were carried out in Japan.

Declaration of Yoshinori Tomita Application No. 19/905,424 Page 3

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to by true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Kivoshi Hirata

July 24

Respectfully submitted,

Dated:

Alison P. Schwartz

Registration No. 43,863

SONNENSCHEIN NATH & ROSENTHAL LLP

P.O. Box 061080

Wacker Drive Station, Sears Tower

Chicago, Illinois 60606-1080

(312) 876-8000



•Proposer Information

[Company	[Inventor	[Proposer	[Belonged Section Name]
Code]	Code]	Name]	
000218	Kiyoshi HIRATA		IMNC PAC Planning Dept. Planning

Inventor Filling Space

[Receipt Number]	02903751	[Date of Receipt]					
[Proposal Number]		[Date of Submission]					
[Title of Invention]	Manufacturing Method of Solid-State Imaging Device						
[Summary of Invention (Invention Department)]	As to a channel stop section which is used for partitioning off a pixel section in a solid-state imaging device, a conventional structure is of the structure that P type impurities are formed by identical energy, whereas in this invention, that structure is changed to another structure that energy is changed and ion implantation is carried out several times, so that it is possible to reduce a smear component which occurs due to a pixel peripheral surface side, and to suppress the color mixture phenomenon that adjacent pixel and photo-electrically converted electric charges are mixed. In addition, by changing an area to which ion implantation is applied with each energy, it is possible to suppress the above-described phenomenon without narrowing a pixel area. It is the invention.						
[Project Name]	01-PJ-108		[Model Number] 0000000				
[Model Name/ Development Type Name]							
[Software Classification]		[Development Status]	Development/Trial Production Stage				
[Publicity Plan]	[Examination Request Desired Filing (Proposer)]						
[Scheduled Day of Publicity]	[Method of Publicity]						

•Inventor

МО	Report Preparation	Inventor Information (Registered)	Inventor Information (Unregistered)	Shared Authentication ID
15 F J	Report Preparation	Company: 000218 Sony Corporation IMNC PAC Belonging: NIM409D Planning Dept. Planning Inventor: 100181 Kiyoshi HIRATA Kiyoshi HIRATA E-mail: kiyoshi@shiba.sony.co.jp		Obtained

•List of Attached Documents

Туре	File	Size	Prepared Date	Receipt Number of Combined Child Matter
Inventor Manuscript	Channel stop multiple state implantation.doc	55,296	00:14:14	
at the time of	Invention report at the time of filing.htm	10,781	12:38:57	
Drawing	02903751.tif	438,784	16:24:02	
	Channel stop multiple state implantation (revised).doc	47,104	16:38:05	
li i	Modified manuscript.doc	45,568	15:09:37	
!	Modification instruction.doc	36,864	15:14:37	

•Prior Art Search [Search Means] IP-NAVI

•Inventor Comment

Searched by Channel Stop, Multiple Implantation, High Energy, but not found.

Documents to be sent separately [List of paper documents to be sent separately]

Immediate Manager Filling Space

Company Priority Processing		[Foreign Filing Desire]	TBD
[Examination Reques			
at the time of Fili	Not desired		
Department)]			
[Department Comment]	Particularly effection miniaturization	ve at the time of cell	

■ Patent Staff Filling Space ■

[Receipt Number]	0290375 1	[Date of Receipt]			
[Filing Type]	Normal Filing	[Detailed Classificati on]			
[Own company/ Other company Classification]	1	[Original Classificati on]	NCOUDT II		company managem
[Title (IP		uring Method o	f Soli	d-State Imagi	ng
Dept.)]	Device				
Department)]	partition imaging of the structure that structure to reduce pixel per the color and photo are mixed which ior energy, indescribed	channel stop section which is used for oning off a pixel section in a solid-state device, a conventional structure is of ucture that P type impurities are formed tical energy, whereas in this invention, ructure is changed to another structure ergy is changed and ion implantation is out several times, so that it is possible ce a smear component which occurs due to a eripheral surface side, and to suppress or mixture phenomenon that adjacent pixel to-electrically converted electric charges ed. In addition, by changing an area to on implantation is applied with each it is possible to suppress the above-ed phenomenon without narrowing a pixel It is the invention.			
[Free Keyword]					
[JK Keyword]					

[Described Content Evaluation]	Class 1:Within Regulation						
[Evaluation Comment]							
[Network Company]	SNC SNC	SNC SNC [Company] NSN1 NSN1					
[Group in charge]	GR GR/Se GP	miconductor Fu	ındamer	tal Device T	echnology		
[Person in charge]	110221 K	110221 Kyoichi DANTOKO					
[Importance Level Evaluation]	Accepta nce Period 0203	Classificati Handling Staff KI			Handlin g Staff kl		
[4 Laws]	Patent	[Examination Request at th of Filing(IP Department)]	e time	No			
[Number of Claims]		[Number of Actual Inventions]		[Request Rank]	B2		
[Office]	ML00 NOD	A Patent Offic	e				
[Writer]	ML02 Osar	nu GAMON					
[Office Request Classification]	Filing Request	[Due Date]					
[Request Content]		a correction. procedure. We		se FAX before	going		

•Final Disposal

Disposal Name	Relevant Information					
Filing	Filing Number: 2002330150 Filing Date: 2002.11.14					
[Date of Deci	sion] [Reason of Decision]					

•Child Matter

ı				P	
ı	INTA!	Dogoine	NT		Approval
ı	TAO	vecerbe	Number	rinai	Approvali
1					
в					

•Applicant

No	Company Name	In charge of Handling	Quota	Detail Input	
L		Classificat	cion		
	000218	In charge of Handling	100%	Company Name: Representative Name:	
1	Sony	Right Holder		Postal Code: Address:	
	COTPOTACION	(Applicant)		Contact Point Tel: Remark:	

•Domestic Priority Filing

No Number	Tyme 4	T.aws	Number
	+3 DG 4	Daws	Marimer

•Original Invention (Division Information)

Number	Туре		4 Laws	Number
		Not	specified	

•Relevant Invention

		MARKET STREET,		****		
11 m m 1			I I	1 1	1 1	1 11
	INIIMPAY	וסרתדוי	Country	A Tara	(NT-1-m) - mi	
		TADG	COULTER	# HGWD	mmmer	ITVDE
:L	I	:	:			1-22-1

•Comment

[An inventor should make a copy of this paper and keeps it for himself/herself.]

[INVENTION REPORT (2)]

[Point of Invention]

This is a portion which becomes a column of [Scope of Claim for Patent] (Claims) in a specification of an application. When there are a plurality of points of an invention (claims), please write all of them with addition of items 1, 2, 3,

- 1. A channel stop structure in which multiple-stage implantation is carried out between vertical direction pixels, by changing energy.
- 2. A channel stop structure in which multiple-stage implantation is carried out between horizontal direction pixels and a vertical transfer section.
- 3. A channel stop structure in which ion implantation is carried out by changing a size with respect to each energy for channel stop.
- 4. A channel stop structure in which ion implantation is carried out by changing P type impurity concentration at each energy.

[Prior Art and its Problem]

This is a portion which becomes a column of [Prior Art] in the specification of the application. Please write prior art and its drawback by citing patent publications, documents etc. as far as possible.

By the matter that a pixel size becomes smaller in an imaging device, a space between a vertical direction pixel and a horizontal direction pixel is narrowed, and in case of a conventional channel stop structure, there occurs the phenomenon that electric charges, into which received light is photo-electrically converted, are mixed with adjacent pixels (hereinafter, called as color mixture phenomenon). In order to prevent the phenomenon, there is need to heighten energy for channel stop, but when energy is heightened to carry out ion implantation, it leads to deterioration of a smear phenomenon due to a surface side.

In addition, by the matter that energy is heightened to carry out ion implantation, it becomes easy to occur diffusion of P type impurities, so that an electric charge storage area is narrowed and lowering of sensitivity and lowering of saturation signal quantity are brought about.

[INVENTION REPORT (3)]

[Concrete Explanation of Invention]

This is a portion which becomes a column of [Embodiment] in the specification of the application. Please explain in detail in accordance with the following procedures.

- Please write an embodiment (apparatus/system in which the invention is used and entirety of a substantial section) which you believe is the best in order to realize this invention
- Please write structures, operations, workings of substantial sections of the invention in detail as far as possible.
- 3. Please write modification examples of the invention as many as possible.
- Note 1: Please write drawings, graphs, flow charts, etc.
 with reference numbers on attached separate papers, and
 please write explanations over citing the reference
 numbers.
- Note 2: In case that there are technical reports etc., please actively make use of them for supplement of the explanations.

One example of a cross section of a structure of an imaging device sensor section is shown in Fig.1 (cross section in a

vertical direction), Fig.2 (cross section in a horizontal direction).

Normally, there is a possibility that, by expansion of an electric charge storage section (14) in a vertical direction (Fig.1), a space between pixels is narrowed and (15), in which there is no channel stop portion between pixels or ion implantation is applied only to its surface, is overlapped with an adjacent pixel to bring about a color mixture phenomenon. In addition, in a horizontal direction (Fig.2), in the same manner, there is a possibility that, by expansion of an electric charge storage section (24), (25), in which ion implantation is applied only to its surface, is overlapped with an adjacent pixel to bring about a color mixture phenomenon.

In order to suppress the color mixture phenomenon, there is need to apply ion implantation of P type impurities to a channel stop portion, deeply in a bulk depth direction, by increasing energy.

In case that ion implantation is simply applied deeply in a bulk depth direction, concentration of P type impurities on a surface side for suppressing a smear component which occurs on a surface, becomes thinner, and it becomes easy to occur the smear phenomenon.

A structure of applying ion implantation of P type impurities to horizontal direction and vertical direction channel stop portions on multiple stages by changing energy, in order to suppress the smear component on the surface side and to suppress the color mixture phenomenon.

In addition, such a structure that, on the occasion of carrying out ion implantation on multiple stages, energy is heightened as represented by Fig.3, and thereby, an area of a portion to which ion implantation is applied is narrowed, and an area in which diffusion occurs at a deep portion in a depth direction is narrowed as much as possible, so as not to narrow a storage area.

As described above, by configuring the multiple stage channel stop portion, an advantage of suppressing a Qknee phenomenon which is brought about by increase of photo-electrically converted electric charges is expected, besides suppression of the smear component on the surface side and suppression of the color mixture phenomenon with an adjacent pixel.

[INVENTION REPORT (4)]

[Concrete	Explanation	of	Invention]	(continuation)	

[Advantage of Invention]

This is a portion which becomes a column of [Advantage of the Invention] in the specification of the application. Please write advantages of the invention, which are predicted, as many as possible.

There is an advantage of preventing the color mixture phenomenon that photo-electrically converted electric charges are mixed with adjacent pixels, by carrying out multiple stage ion implantation, with changing energy of a channel stop between vertical direction pixels and a channel stop between a horizontal direction electric charge storage section and a vertical transfer section.

An advantage of preventing the color mixture phenomenon without narrowing an electric charge storage area and without lowering sensitivity and saturation signal quantity, by

reducing a size of ion implantation by high energy.

An advantage of reducing fluctuation of an overflow barrier at the time that electric charges were stored and preventing Qknee, by applying ion implantation to a channel stop with high energy.

An advantage of suppressing a smear phenomenon due to a surface side and a smear phenomenon due to an inside of a bulk, by realizing the configuration that ion implantation is applied to a channel stop between a horizontal electric charge storage section and a vertical transfer section by changing energy.

[When a paper space is not enough, please make use of an arbitrary paper such as a report writing paper, and write in detail as far as possible.]

[INVENTION REPORT (5)]

[Drawing]

As a general rule, please make use of this drawing writing paper. In this regard, however, if there is an existing drawing such as a design drawing, a CAD drawing, and a specification sheet, there is no problem to make use of it. In addition, there is also no problem to make use of it together with this drawing writing paper.

[Fig.1]

[Fig.2]

[When a paper space is not enough, please make use of an arbitrary paper such as a report writing paper, and write in detail as far as possible.]

[Fig.3]

発 明 報 告 書 (2)

多のNY 発明者の控はご自身でコピー して保管して下さい。

発明のポイント

出願明細書中の 特許請求の範囲 (クレーム)の欄となるところです。発明のポイント (クレーム) が複数有るときには、1、2、3、…の項目を付してその全てをお書き下さい。

- 1. 垂直方向画素間にエネルギーを変えて多段に打つチャネルストップ構造
- 2. 水平方向画素と垂直転送部間にエネルギーを変えて多段に打つチャネルストップ構造
- 3. チャネルストップのエネルギーごとにサイズを変えてイオン注入するチャネルストップ 構造
- 4. 各エネルギーのP型不純物濃度を変えてイオン注入するチャネルストップ構造

後来鼓術とその問題点

出願明細書中の 従来の技術 の欄となるところです。従来の技術とその欠点を特許公 報、文献等をできるだけ引用して書いて下さい。

撮像素子における画素サイズが小さくなることにより、垂直方向及び水平方向の画素間が狭まり、受光し光電変換された電荷が従来のチャネルストップの構造であれば、隣接画素へ混ざる現象(以下、混色現象と呼ぶ)が起きる。その現象を防止するためにはチャネルストップのエネルギーを高くする必要があるが、エネルギーを高くしてイオン注入をすると、表面側起因のスミア現象の悪化に繋がる。また、エネルギーを高くしてイオン注入することにより、P型不純物の拡散が起きやすくなり、電荷蓄積領域を狭め、感度の低下、飽和信号量の低下を引き起こす。

発 明 報 告 書 (3)

発明の具体的説明

出願明細書中の実施例の個となるところです。以下の手順に従って詳細に説明して下さい。

- 1. この発明を実現するのに、あなたが最良と信じる実施態様(発明が使用される装置・システム及び要部の全体)を書いて下さい。
- 2. その発明の要部の構成、動作、作用をできるだけ詳細に書いて下さい。
- 3. その発明の変形例をできるだけ沢山書いて下さい。

注1:図面、グラフ、フローチャート等は別紙に参照番号を付けて描き、説明はその参照番号を引用しながら書いて下さい。

注2:技術レポート等がある場合には、説明の補充に積極的に利用して下さい。

撮像素子センサ部の構造の断面の一例を図1(垂直方向の断面)、図2(水平方向の断面)に示す。 通常、垂直方向(図1)において電荷蓄積部(14)の広がりによって、画素間が狭く画素間の チャネルストップ部が無いあるいは表面のみにしかイオン注入されていない(15)と隣接画素と 重なりを持ち、混色現象を引き起こす可能性がある。また水平方向(図2)においても同様に、 電荷蓄積部(24)の広がりによって、チャネルストップ部が表面のみにしかイオン注入されていない (25)と隣接画素と重なりを持ち、混色現象を引き起こす可能性がある。

その混色現象を抑えるため、チャネルストップ部にP型不純物をエネルギーを上げバルク深さ方向深くにイオン注入する必要がある。

バルク深さ方向深くにイオン注入するのみであると、表面で起きるスミア成分を抑える表面側の P型不純物の濃度が薄くなり、スミア現象が起きやすくなる。

表面側のスミア成分を抑え且つ混色現象を抑えるため、水平方向及び垂直方向のチャネルストップ 部にエネルギーを変え多段でP型不純物をイオン注入する構造。

また、その多段でイオン注入する際に、図3に代表されるようにエネルギーを高くしてイオン注入する部分の面積を狭め、深さ方向深くにおいて拡散する領域を極力狭め、蓄積領域を狭めないようにする構造。

また、その多段でイオン注入する際に、エネルギーを高くしてイオン注入する部分の濃度を薄くし、 深さ方向深くにおいて拡散する領域を極力狭め、蓄積領域を狭めないようにする構造。

上記のようにチャネルストップ部を多段で構成することにより、表面側のスミア成分の抑制、隣接 画素との混色現象の抑制の他に、光電変換された電荷が増加することにより引き起こされるQknee 現象を抑制する効果も期待される。 (続)

発明の効果

出願明細書中の 発明の効果 の欄となるところです。予測される発明の効果をできるだけ沢山書いて下さい。

垂直方向の画素間チャネルストップ及び水平方向電荷蓄積部と垂直転送部間のチャネルストップ のエネルギーを変え多段に打つことにより、光電変換された電荷が隣接画素へ混ざる混色現象を防ぐ 効果がある。

高エネルギーでイオン注入するサイズを小さくすることにより、電荷蓄積領域を狭めず、感度、飽和信号量の低下なく混色現象を防ぐ効果。

チャネルストップを高エネルギーでイオン注入することにより、電荷が蓄積された時のオーバーフローバリアの変動を小さくし、Qkneeを抑制する効果。

水平方向電荷蓄積部と垂直転送部間のチャネルストップをエネルギーを変えて打つ構造にすることにより、表面側起因のスミア現象とバルク中起因のスミア現象を抑制する効果。

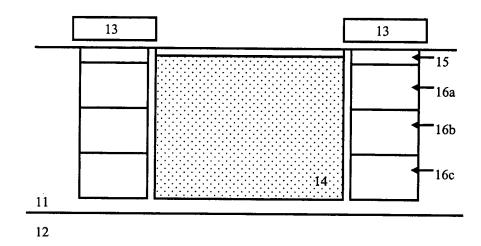
紙面が不足のときは、レポート用紙等の任意の用紙を利用してできるだけ詳細に書いて下さい。

発 明 報 告 書 (5)

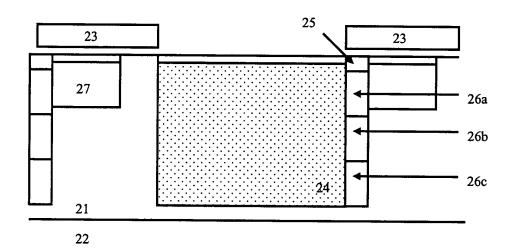


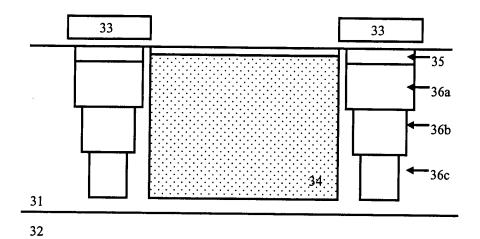
原則として本図面用紙をご利用下さい。但し、設計図、CAD図、仕様書等の既存図面が有ればそれを 利用してもかまいません。又本図面用紙と併用してもかまいません。

【図1】



【図2】







CERTIFICATION

I, Isamu Kitade, ARK MORI Bldg., 13F, No. 12-32, Akasaka 1-chome, Minato-ku, Tokyo, Japan, do hereby certify that I am conversant with the English and Japanese languages and am a competent translator thereof, and I further certify that to the best of my knowledge and belief the attached English translation is a true and correct translation made by me of the "Invention Report" (Proposal No.) dated by the Inventor, Kiyoshi Hirata, corresponding to U.S. Serial Number 10/705,552 filed November 11, 2003, titled "SOLID STATE IMAGING DEVICE AND METHOD FOR MANUFACTURING THE SAME".

Signed this on the 11th day of July, 2005

Isamu Kitade